



Hop Industries Corporation

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Data Information Sheet
Typical Properties of BVDC H1X Film
Anti-Static Vacuum Forming Grade

Description

BVDC H1X is a clear rigid PVC film with gloss/gloss surface. With a static dissipative function BVDC H1X is engineered for use in thermoforming applications. Typical applications are for thermoformed trays, lids and clamshell containers offering structural and electrostatic protection of sensitive electronic components. Special requirement options of BVDC H1X include (but not limited to):

Customized Impact Strengths – MXX=Medium, HXX=High, VXX=Very High, EXX=Extra High

Table with 3 columns: Property, Test Method, Typical Values. Rows include Thickness (mils), Thickness tolerance, Width Tolerance, Color, Gloss Value (60°), Specific Gravity, Tensile Strength (psi), Elongation (%), Surface Resistivity, Static decay rate, Contact Corrosivity, Out gassing, Polycarbonate Compatibility, Impact Strength, Cold Break Temperature.

Note: ASTM-D1790 is based on the Annual Book 1992. The other ASTM methods above are based on the Annual Book 1999 and have been modified to suit practical applications.

\* For dimensions and/or physical properties different from what is listed above or special requirements including weather ability and flammability, etc., contact the vendor for the agreement on the specifications.

\*\* Factory Product Self Inspection and Test Methods.

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